VDSS

650V



Multi-Epi Super Junction MOSFETs

P6

Lead Free Package and Finish

RDS(ON)(Max.)

420mΩ

Applications:

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply(UPS)
- •PFC stages for server & telecom
- •Consumer

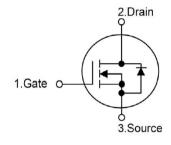
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- •New revolutionary high voltage technology
- •Better RDS(on) in TO-220F
- •Ultra Low Gate Charge cause lower driving requirements
- ·Periodic avalanche rated
- •Ultra low effective capacitances



ΙD

12A



Not to Scale

Ordering Information

Part Number	Package	Marking
RSU12N65F	TO-220F	RSU12N65F

Absolute Maximun Ratings Tc=25℃ unless otherwise specified

Symbol	Parameter	RSU12N65F	Units	
VDSS	Drain-to-Source Voltage	650	V	
ID	Continuous Drain Current (TC = 25°C)	12		
ID	Continuous Drain Current (TC = 100℃)	7	Α	
IDM	Pulsed Drain Current (Note*1)	44	1	
PD	Power Dissipation(Tc=25 ℃)	31	W	
VGS	Gate-to-Source Voltage	±30	V	
EAS	Single Pulse Avalanche Engergy (Note*2)	120	mJ	
IAR	Avalanche Current (Note*1)	1.8	Α	
EAR	Repetitive Avalanche Engergy (Note*1)	0.32	mJ	
	Maximum Temperature for Soldering			
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds	300 260	$^{\circ}$ C	
	Package Body for 10 seconds		C	
T. Land TOTO	Operating Junction and Storage	-55 to 150		
TJ and TSTG	Temperature Range	-55 to 150		

^{*}Drain Current Limited by Maximum Junction Temperature

Caution:Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.

Thermal Resistance

Symbol	Parameter	RSU12N65F	Units	Test Conditions
RθJC	Junction-to-Case	4	°C/W	Drain lead soldered to water cooled heatsink,PD Adjusted for a peak junction temperature of +150 ℃.
RθJA	Junction-to-Ambient	78		1 cubic foot chamber,free air.



OFF Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
DVDee	Drain-to-source Breakdown Voltage	650	-1		٧	VGS = 0V, ID = 250μ A, TJ= 25° C
BVDSS			650		٧	VGS = 0V, ID = 250μA, TJ= 150℃
IDSS	Drain-to-Source Leakage Current			1.0	μA	VDS=650V,VGS=0V
IGSS	Gate-to-Source Forward Leakage			VGS=+30V VDS=0V		
1000	Gate-to-Source Reverse Leakage			-100	nA	VGS=-30V VDS=0V

ON Characteristics TJ=25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain-to-Source On-Resistance		380	420	mΩ	VGS=10V,ID=6A
VGS(TH)	Gate Threshold Voltage	3.5	4	4.5	V	VGS=VDS,ID=250µA
gfs	Transconductance		40		S	VDS=20V,ID=6A

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn-on Delay Time		21			VDS=400V
trise	Rise Time		20			ID=6A
td(OFF)	Turn-OFF Delay Time		51		ns	RG=25Ω
tfall	Fall Time		40			VGS=10V

Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		850			VGS=0V
Coss	Output Capacitance		35		pF	VDS=100V
Crss	Reverse Transfer Capacitance		5			f=1.0MHz
Qg	Total Gate Charge		19			VDS=520V
Qgs	Gate-to-Source Charge		6		nC	ID=12A
Qgd	Gate-to-Drain("Miller") Charge		6			VGS=10V

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Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current		-	12	Α	Integral pn-diode
ISM	Maximum Pulsed Current			44	Α	in MOSFET
VSD	Diode Forward Voltage		0.9	1.2	V	IS=12A,VGS=0V Tj=25℃
trr	Reverse Recovery Time		212		nS	VR=400V,VGS=0V
Qrr	Reverse Recovery Charge		2.28		μC	IS=12A,di/dt=100A/μs

Notes:

Typical Feature curve $T_J=25^{\circ}C$, unless otherwise noted



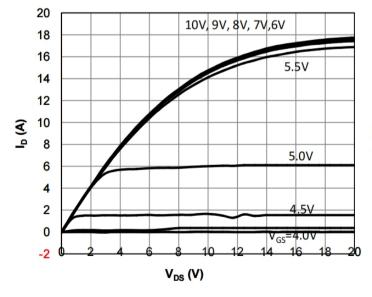
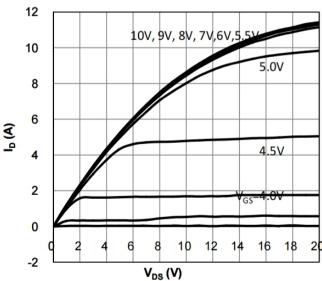


Fig 2. Output Characteristics (Tj=125℃)



^{*1.}Repetitive rating; pulse width limited by maximum junction temperature.

^{*2.} IAS = 1.8A, VDD = 50V, RG = 25Ω , Starting TJ = 25° CPulse width tp limited by Tj,max

Fig 3: Transfer Characteristics

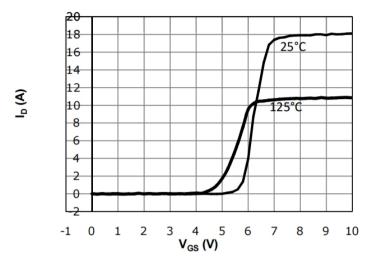


Fig 5: Rdson Vs Ids Characteristics(Tc=25℃)

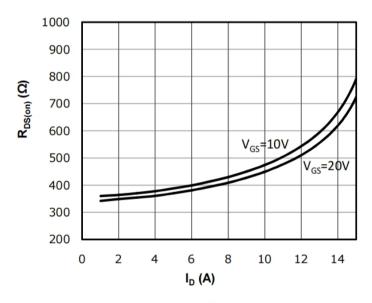


Fig 7: BVDSS vs. Temperature Characteristics

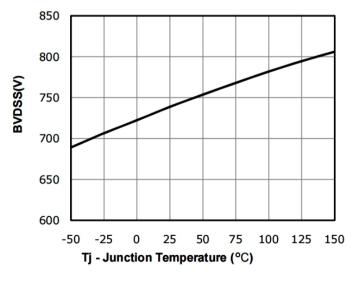


Fig 4: V_{TH} Vs Tj Temperature Characteristics

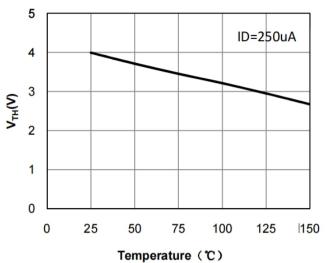


Fig 6: Rds(on) vs. Temperature

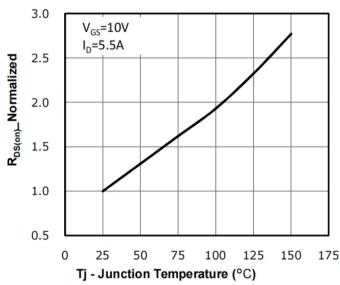
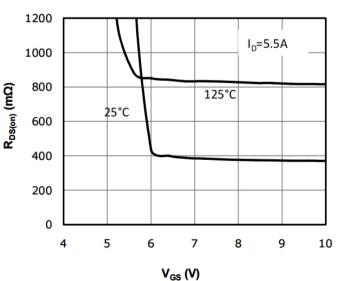


Fig 8: Rds(on) vs Gate Voltage



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Fig 9: Body-diode Forward Characteristics

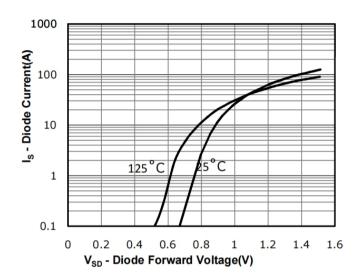


Fig 10: Gate Charge Characteristics

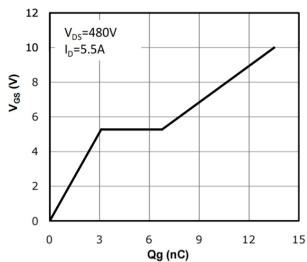


Fig 11: Capacitance Characteristics

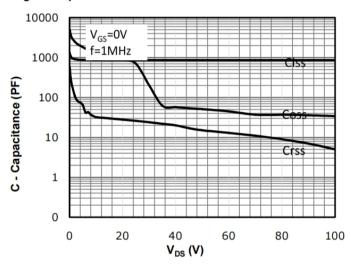
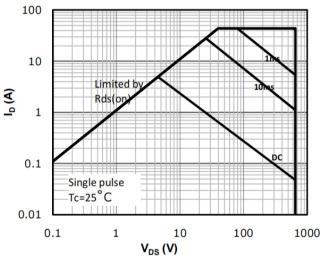


Fig 12: Safe Operating Area





Test Circuits and Waveforms

Figure A: Gate Charge Test Circuit and Waveform

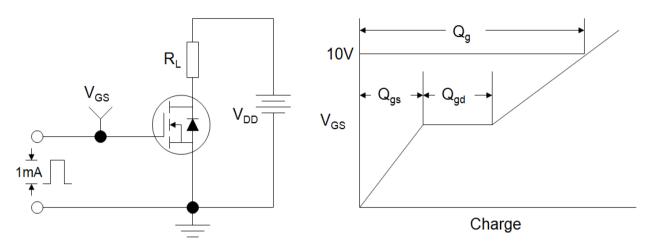


Figure B: Resistive Switching Test Circuit and Waveform

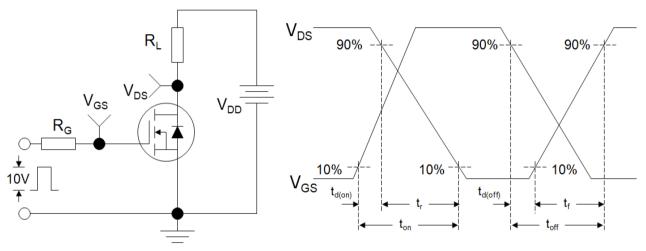
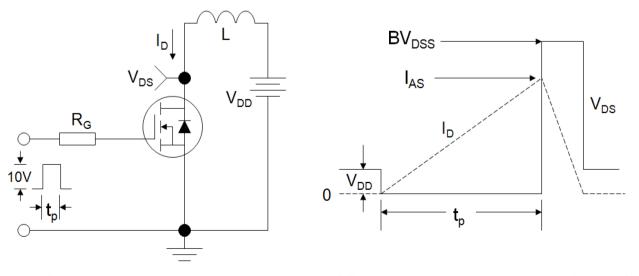


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



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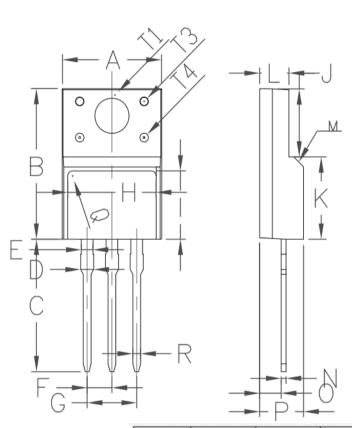
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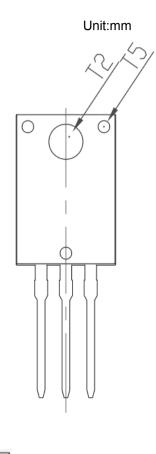
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Package outline drawing





Symbol	Min	Non	Max
A	9.96	10.16	10.36
В	15.67	15.87	16.07
C	13.14	13.34	13.54
D	1.20	1.30	1.40
E		1.20	
F		2.54	
G		5.08	
H	7.60	7.80	8.00
I	7.10	7.30	7.50
J	6.48	6.68	6.88
K	8.99	9.19	9.39
L	2.34	2.54	2.74
M		45°	
N	0.49	0.50	0.52
0	2.15	2.35	2.55
P	4.50	4.70	4.90
Q		0.50	
S	4°	4.5°	5°
T1		3.45	
T2		3.18	
T3		1.50	
T4		1.20	
T5		1.50	
R	0.77	0.8	0.83

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